

16. (Original) The structure as recited in claim 14, wherein a bond-line thickness of the second adhesive layer is determined by a pair of ridges extending outward from substantially planar sidewall surfaces of the groove of the other joining member.

17. (Original) The structure as recited in claim 14, wherein the first and second adhesive layers comprise epoxy adhesive materials.

REMARKS/ARGUMENTS

Claim 1 was rejected in light of the prior art and claims 14-17 were allowed.

Claims 14-17 should remain in condition for allowance.

Other claims have been cancelled without disclaimer of the subject matter of the claims.

In closing, I wish to express my appreciation for your kind consideration and helpful comments.

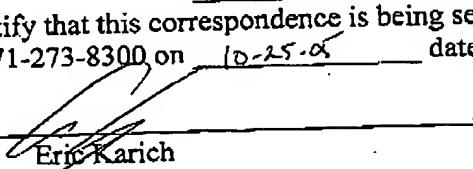
Respectfully submitted,

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I hereby certify that this correspondence is being sent via facsimile to the Commissioner for Patents at 571-273-8300 on 10-25-05 date of deposit.

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